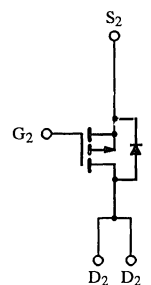
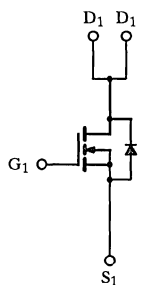
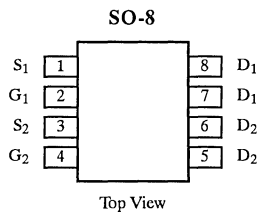


Dual Enhancement-Mode MOSFET (N- and P-Channel)

Product Summary

| | V _{DS} (V) | r _{DS(on)} (Ω) | I _D (A) |
|-----------|---------------------|----------------------------------|--------------------|
| N-Channel | 20 | 0.125 @ V _{GS} = 10 V | ± 3.0 |
| | | 0.250 @ V _{GS} = 4.5 V | ± 2.0 |
| P-Channel | -20 | 0.160 @ V _{GS} = -10 V | ± 2.8 |
| | | 0.300 @ V _{GS} = -4.5 V | ± 2.0 |



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Absolute Maximum Ratings (T_A = 25°C Unless Otherwise Noted)

| Parameter | Symbol | N-Channel | P-Channel | Unit | |
|--|-----------------------------------|-----------------------|-----------|-------|---|
| Drain-Source Voltage | V _{DS} | 20 | -20 | V | |
| Gate-Source Voltage | V _{GS} | ± 20 | ± 20 | | |
| Continuous Drain Current (T _J = 150°C) | I _D | T _A = 25°C | ± 3.0 | ± 2.8 | A |
| | | T _A = 70°C | ± 2.5 | ± 2.3 | |
| Pulsed Drain Current | I _{DM} | ± 10 | ± 10 | | |
| Continuous Source Current (Diode Conduction) | I _S | 1.6 | -1.6 | | |
| Maximum Power Dissipation (Surface Mounted on FR4 Board) | P _D | T _A = 25°C | 2.0 | | W |
| | | T _A = 70°C | 1.3 | | |
| Operating Junction and Storage Temperature Range | T _J , T _{stg} | -55 to 150 | | °C | |

Thermal Resistance Ratings

| Parameter | Symbol | N- or P-Channel | Unit |
|--|-------------------|-----------------|------|
| Maximum Junction-to-Ambient (Surface Mounted on FR4 Board) | R _{thJA} | 62.5 | °C/W |

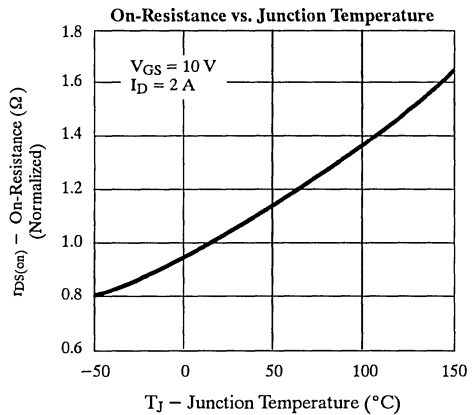
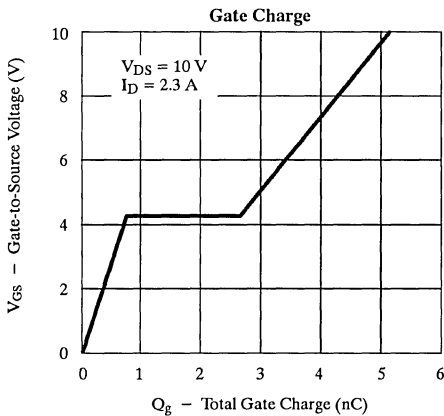
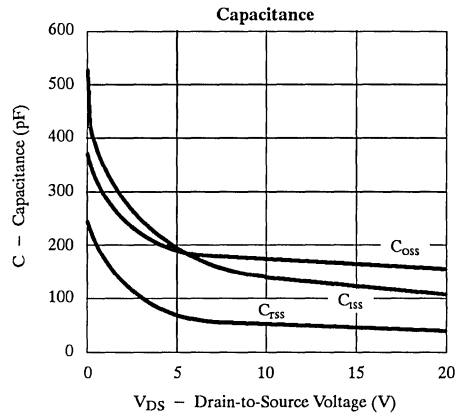
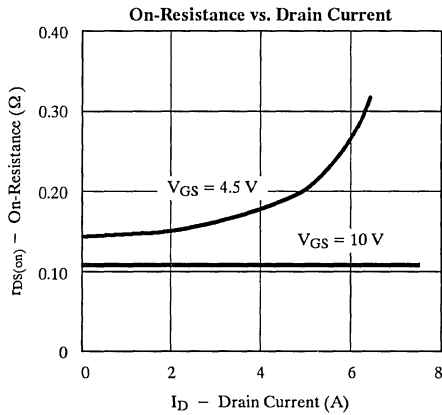
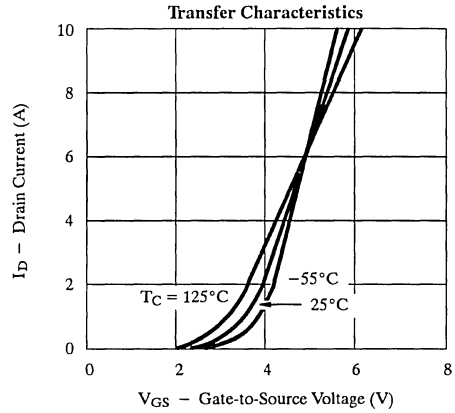
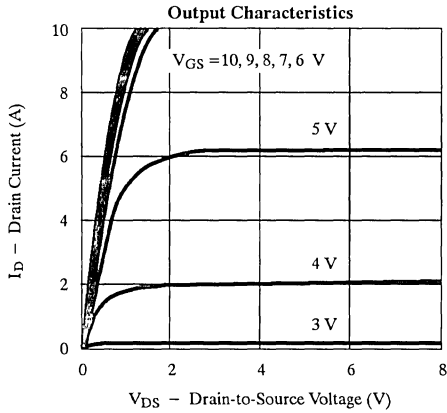
Si9943DY

Specifications ($T_J = 25^\circ\text{C}$ Unless Otherwise Noted)

| Parameter | Symbol | Test Condition | Min | Typ ^a | Max | Unit |
|---|--------------|---|---|------------------|-----------|---------------|
| Static | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$ | N-Ch | 1.0 | | V |
| | | $V_{DS} = V_{GS}, I_D = -250 \mu\text{A}$ | P-Ch | -1.0 | | |
| Gate-Body Leakage | I_{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 16 \text{ V}, V_{GS} = 0 \text{ V}$ | N-Ch | | 2 | μA |
| | | $V_{DS} = -16 \text{ V}, V_{GS} = 0 \text{ V}$ | P-Ch | | -2 | |
| | | $V_{DS} = 16 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^\circ\text{C}$ | N-Ch | | 25 | |
| | | $V_{DS} = -16 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^\circ\text{C}$ | P-Ch | | -25 | |
| On-State Drain Current ^b | $I_{D(on)}$ | $V_{DS} \geq 5 \text{ V}, V_{GS} = 10 \text{ V}$ | N-Ch | 10 | | A |
| | | $V_{DS} \leq -5 \text{ V}, V_{GS} = -10 \text{ V}$ | P-Ch | -10 | | |
| | | $V_{DS} \geq 5 \text{ V}, V_{GS} = 4.5 \text{ V}$ | N-Ch | 2 | | |
| | | $V_{DS} \leq -5 \text{ V}, V_{GS} = -4.5 \text{ V}$ | P-Ch | -2 | | |
| Drain-Source On-State Resistance ^b | $r_{DS(on)}$ | $V_{GS} = 10 \text{ V}, I_D = 3.0 \text{ A}$ | N-Ch | 0.100 | 0.125 | Ω |
| | | $V_{GS} = -10 \text{ V}, I_D = 3.0 \text{ A}$ | P-Ch | 0.100 | 0.160 | |
| | | $V_{GS} = 6 \text{ V}, I_D = 2.0 \text{ A}$ | N-Ch | 0.120 | 0.160 | |
| | | $V_{GS} = -6 \text{ V}, I_D = 2.0 \text{ A}$ | P-Ch | 0.120 | 0.200 | |
| | | $V_{GS} = 4.5 \text{ V}, I_D = 1.5 \text{ A}$ | N-Ch | 0.160 | 0.250 | |
| | | $V_{GS} = -4.5 \text{ V}, I_D = 1.5 \text{ A}$ | P-Ch | 0.20 | 0.300 | |
| Forward Transconductance ^b | g_{fs} | $V_{DS} = 15 \text{ V}, I_D = 3.0 \text{ A}$ | N-Ch | 3.7 | | S |
| | | $V_{DS} = -15 \text{ V}, I_D = -3.0 \text{ A}$ | P-Ch | 3.0 | | |
| Diode Forward Voltage ^b | V_{SD} | $I_S = 1.25 \text{ A}, V_{GS} = 0 \text{ V}$ | N-Ch | 0.9 | 1.2 | V |
| | | $I_S = -1.25 \text{ A}, V_{GS} = 0 \text{ V}$ | P-Ch | -1.4 | -1.6 | |
| Dynamic^a | | | | | | |
| Total Gate Charge | Q_g | $V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 2.3 \text{ A}$ N-Channel $V_{DS} = -10 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -2.3 \text{ A}$ P-Channel | N-Ch | 5.2 | 25 | nC |
| Gate-Source Charge | Q_{gs} | | N-Ch | 0.8 | | |
| | | | P-Ch | 1.3 | | |
| Gate-Drain Charge | Q_{gd} | | N-Ch | 2.0 | | |
| | | P-Ch | 2.0 | | | |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{DD} = 20 \text{ V}, R_L = 20 \Omega$ $I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_G = 6 \Omega$ N-Channel $V_{DD} = -20 \text{ V}, R_L = 20 \Omega$ $I_D \cong -1 \text{ A}, V_{GEN} = -10 \text{ V}, R_G = 6 \Omega$ P-Channel | N-Ch | 5 | 15 | ns |
| Rise Time | t_r | | N-Ch | 12 | 40 | |
| | | | P-Ch | 10 | 20 | |
| Turn-Off Delay Time | $t_{d(off)}$ | | N-Ch | 19 | 40 | |
| | | | P-Ch | 25 | 50 | |
| Fall Time | t_f | | N-Ch | 42 | 90 | |
| | | | P-Ch | 22 | 50 | |
| Source-Drain Reverse Recovery Time | t_{rr} | | $I_F = 1.25 \text{ A}, di/dt = 100 \text{ A}/\mu\text{s}$ | N-Ch | 69 | |
| | | | P-Ch | 69 | 100 | |

Notes

- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.

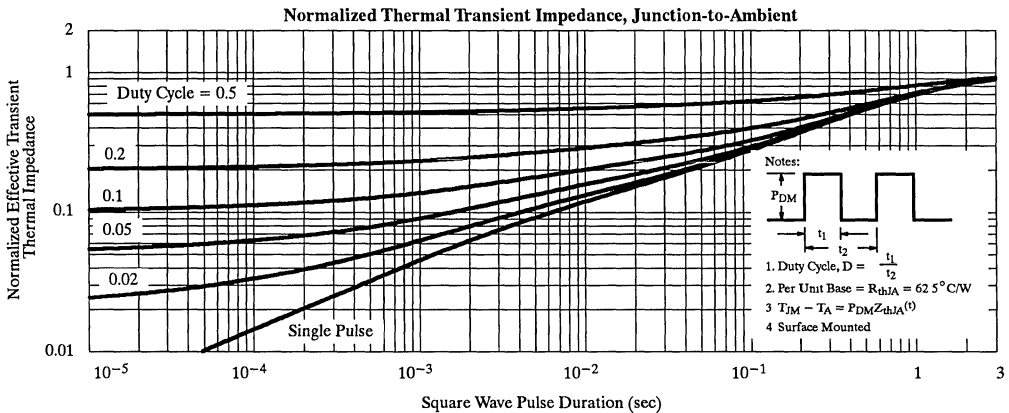
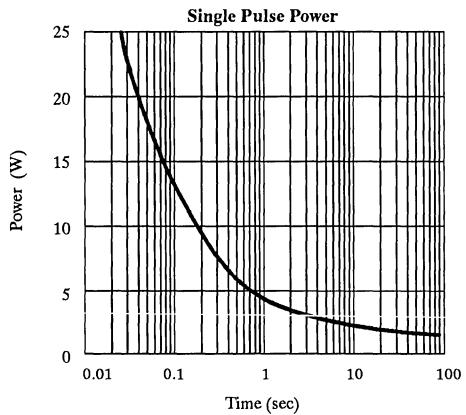
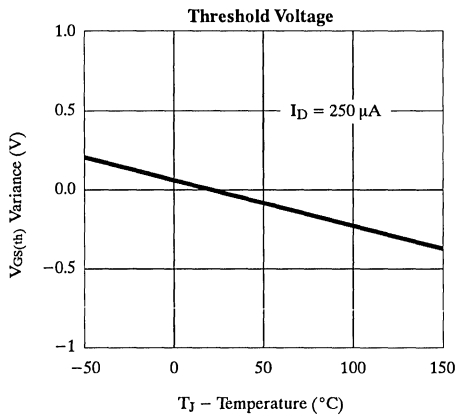
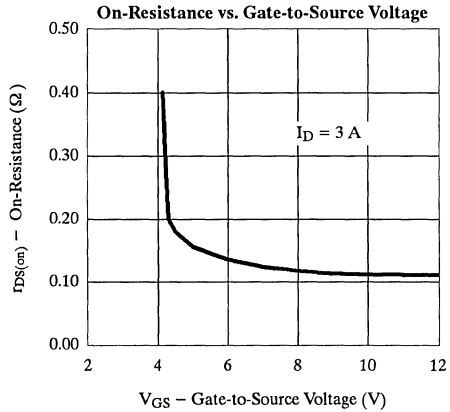
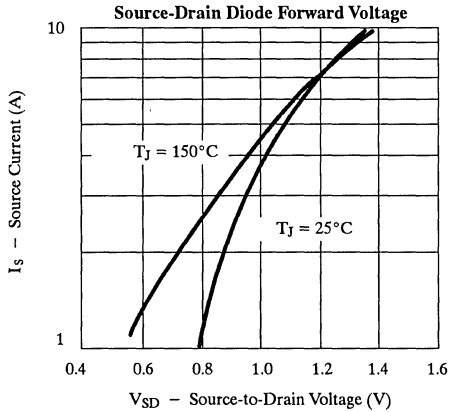


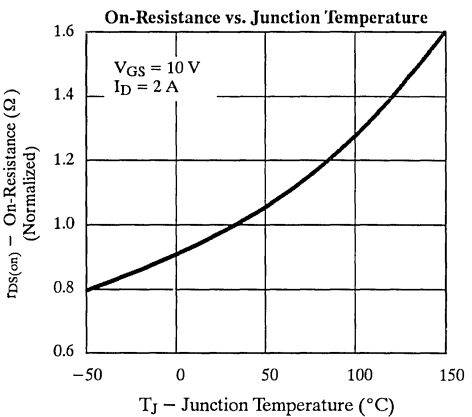
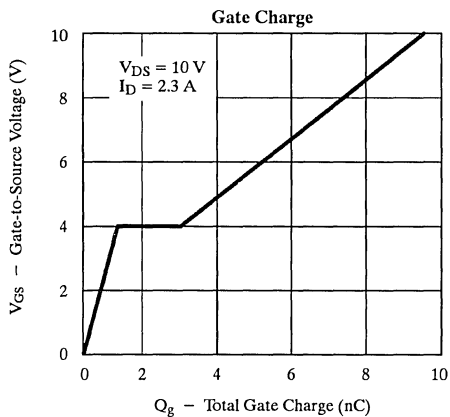
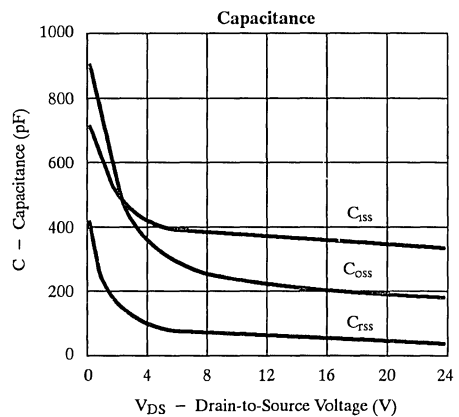
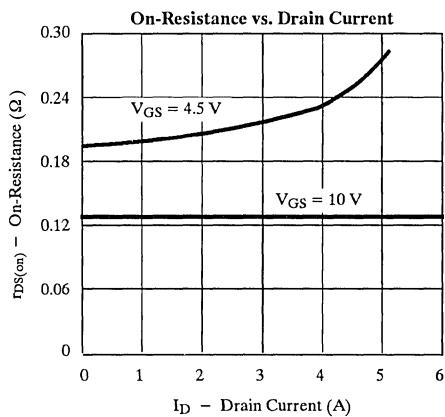
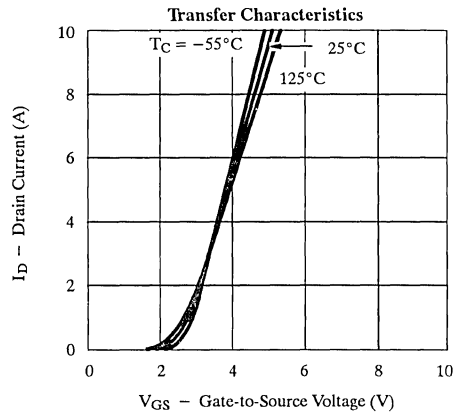
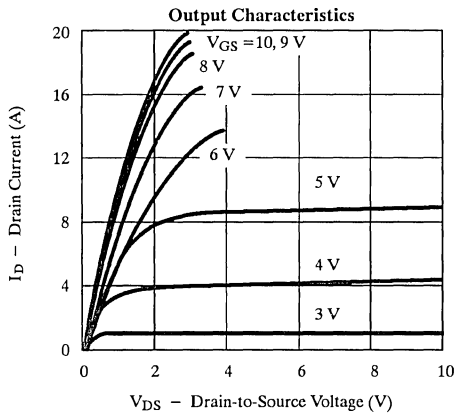
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Typical Characteristics (25°C Unless Otherwise Noted)

N-Channel





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Typical Characteristics (25°C Unless Otherwise Noted)

P-Channel

